

**EXHIBIT C**

**Receipt is hereby acknowledged for the following in the U.S. Patent and Trademark Office:**

**Applicant(s):** Fleming et al.

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**Title:** MICRONEEDLE DEVICES AND METHODS OF MANUFACTURE

**Enclosed:** Submission of Drawings Under 37 C.F.R. 1.85 (1 pg); Formal Drawings (7 pgs); and transmittal document (in triplicate).

**Mailed:** May 29, 2002 via Express Mail No. EV 073 732 029 US  
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